



# TYN210 ---> TYN1010

SCR

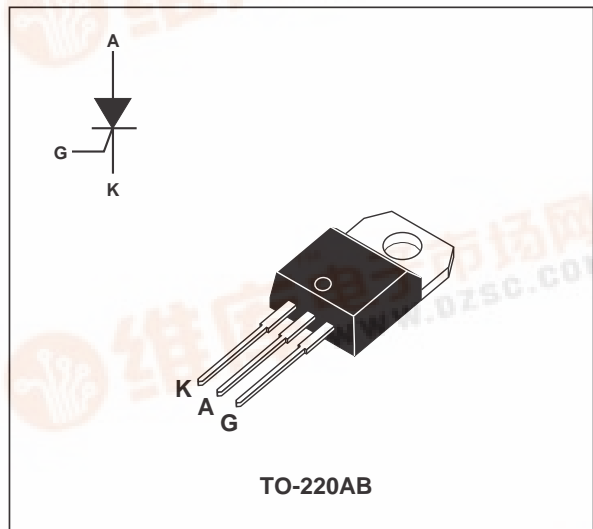
## FEATURES

- High surge capability
- High on-state current
- High stability and reliability

## DESCRIPTION

The TYN210 ---> TYN1010 Family of Silicon Controlled Rectifiers uses a high performance glass passivated technology.

This general purpose Family of Silicon Controlled Rectifiers is designed for power supplies up to 400Hz on resistive or inductive load.



## ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit	
$I_{T(RMS)}$	RMS on-state current (180° conduction angle)	$T_c = 100^\circ\text{C}$ 10	A	
$I_{T(AV)}$	Average on-state current (180° conduction angle, single phase circuit)	$T_c = 100^\circ\text{C}$ 6.4	A	
$I_{TSM}$	Non repetitive surge peak on-state current ( $T_j$ initial = 25°C)	$t_p = 8.3\text{ms}$	105	A
		$t_p = 10\text{ms}$	100	
$I^2t$	$I^2t$ value	$t_p = 10\text{ms}$	50	A <sup>2</sup> s
$di/dt$	Critical rate of rise of on-state current Gate supply: $I_G = 100\text{mA}$ $di/dt = 1\text{A}/\mu\text{s}$		50	A/ $\mu\text{s}$
$T_{stg}$ $T_j$	Storage and operating junction temperature range	-40 to +150 -40 to +125		°C
$T_l$	Maximum lead soldering temperature during 10s at 4.5mm from case	260		°C

Symbol	Parameter	TYN					Unit
		210	410	610	810	1010	
$V_{DRM}$ $V_{RRM}$	Repetitive peak off-state voltage $T_j = 125^\circ\text{C}$	200	400	600	800	1000	V

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### THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
Rth (j-a)	Junction to ambient	60	°C/W
Rth (j-c) DC	Junction to case for DC	2.5	°C/W

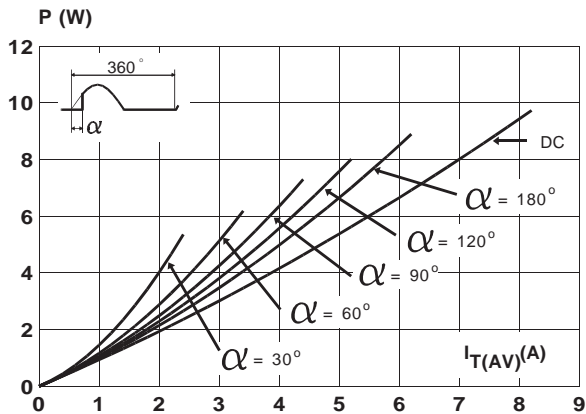
### GATE CHARACTERISTICS (maximum values)

$$P_{G(AV)} = 1W \quad P_{GM} = 10W \quad (t_p = 20\mu s) \quad I_{FGM} = 4A \quad (t_p = 20\mu s) \quad V_{RGM} = 5V$$

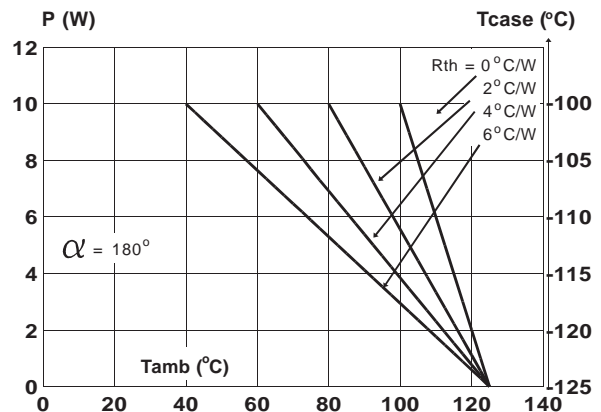
### ELECTRICAL CHARACTERISTICS

Symbol	Test conditions	Value	Unit
$I_{GT}$	$V_D = 12V$ (DC) $R_L = 33\Omega$	$T_j = 25^\circ C$ MAX.	15 mA
$V_{GT}$	$V_D = 12V$ (DC) $R_L = 33\Omega$	$T_j = 25^\circ C$ MAX.	1.5 V
$V_{GD}$	$V_D = V_{DRM}$ $R_L = 3.3k\Omega$	$T_j = 110^\circ C$ MIN.	0.2 V
tgt	$V_D = V_{DRM}$ $I_G = 40mA$ $di_G/dt = 0.5A/\mu s$	$T_j = 25^\circ C$ TYP.	2 $\mu s$
$I_L$	$I_G = 1.2I_{GT}$	$T_j = 25^\circ C$ TYP.	50 mA
$I_H$	$I_T = 100mA$ Gate open	$T_j = 25^\circ C$ MAX.	30 mA
$V_{TM}$	$I_{TM} = 20A$ $t_p = 380\mu s$	$T_j = 25^\circ C$ MAX.	1.6 V
$I_{DRM}$ $I_{RRM}$	$V_{DRM}$ rated $V_{RRM}$ rated	$T_j = 25^\circ C$ MAX. $T_j = 110^\circ C$ MAX.	0.01 mA 2 mA
dV/dt	Linear slope up to $V_D = 67\% V_{DRM}$ gate open	$T_j = 110^\circ C$ MIN.	200 V/ $\mu s$
tq	$V_D = 67\% V_{DRM}$ $I_{TM} = 20A$ $V_R = 25V$ $di_{TM}/dt = 30 A/\mu s$ $dV_D/dt = 50V/\mu s$	$T_j = 110^\circ C$ TYP.	70 $\mu s$

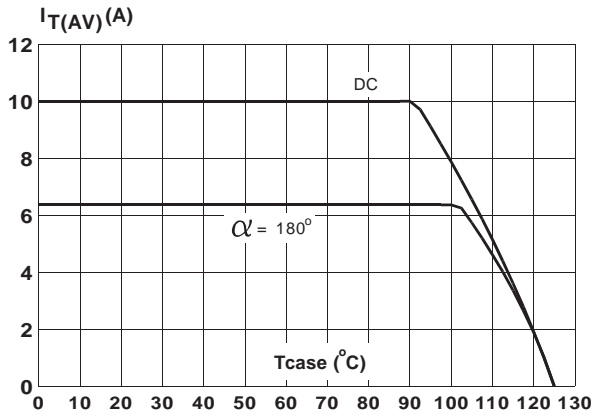
**Fig. 1:** Maximum average power dissipation versus average on-state current.



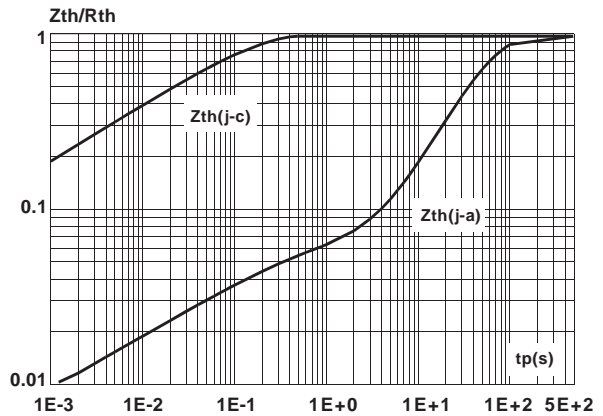
**Fig. 2:** Correlation between maximum average power dissipation and maximum allowable temperatures ( $T_{amb}$  and  $T_{case}$ ) for different thermal resistances heatsink + contact.



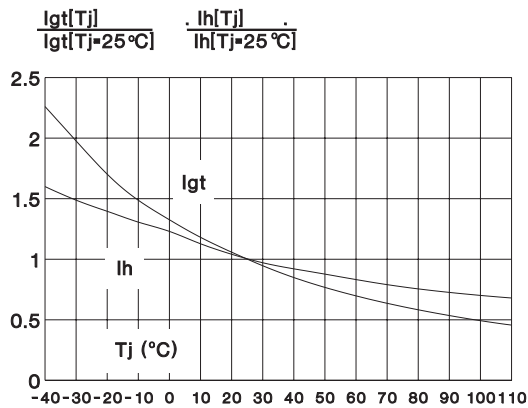
**Fig. 3:** Average on-state current versus case temperature.



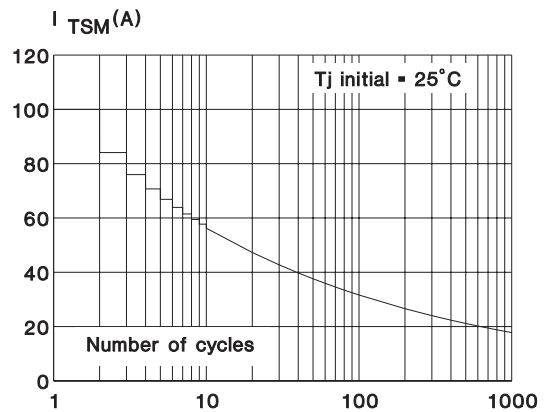
**Fig. 4:** Relative variation of thermal impedance versus pulse duration.



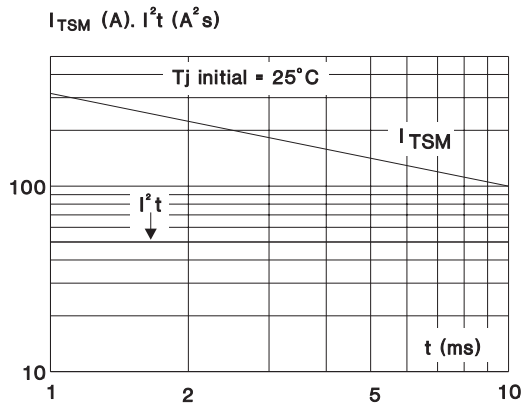
**Fig. 5:** Relative variation of gate trigger current versus junction temperature.



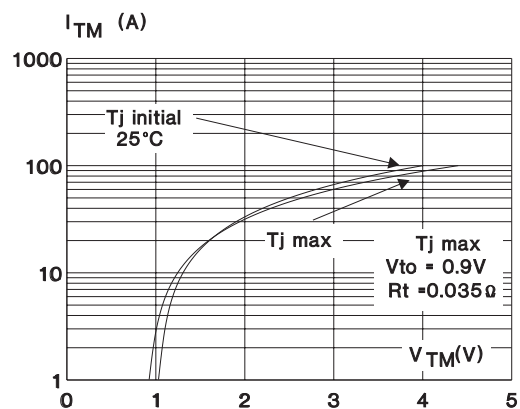
**Fig. 6:** Non repetitive surge peak on-state current versus number of cycles.



**Fig. 7:** Non repetitive surge peak on-state current for a sinusoidal pulse with width:  $t \leq 10\text{ms}$ , and corresponding value of  $I^2t$ .

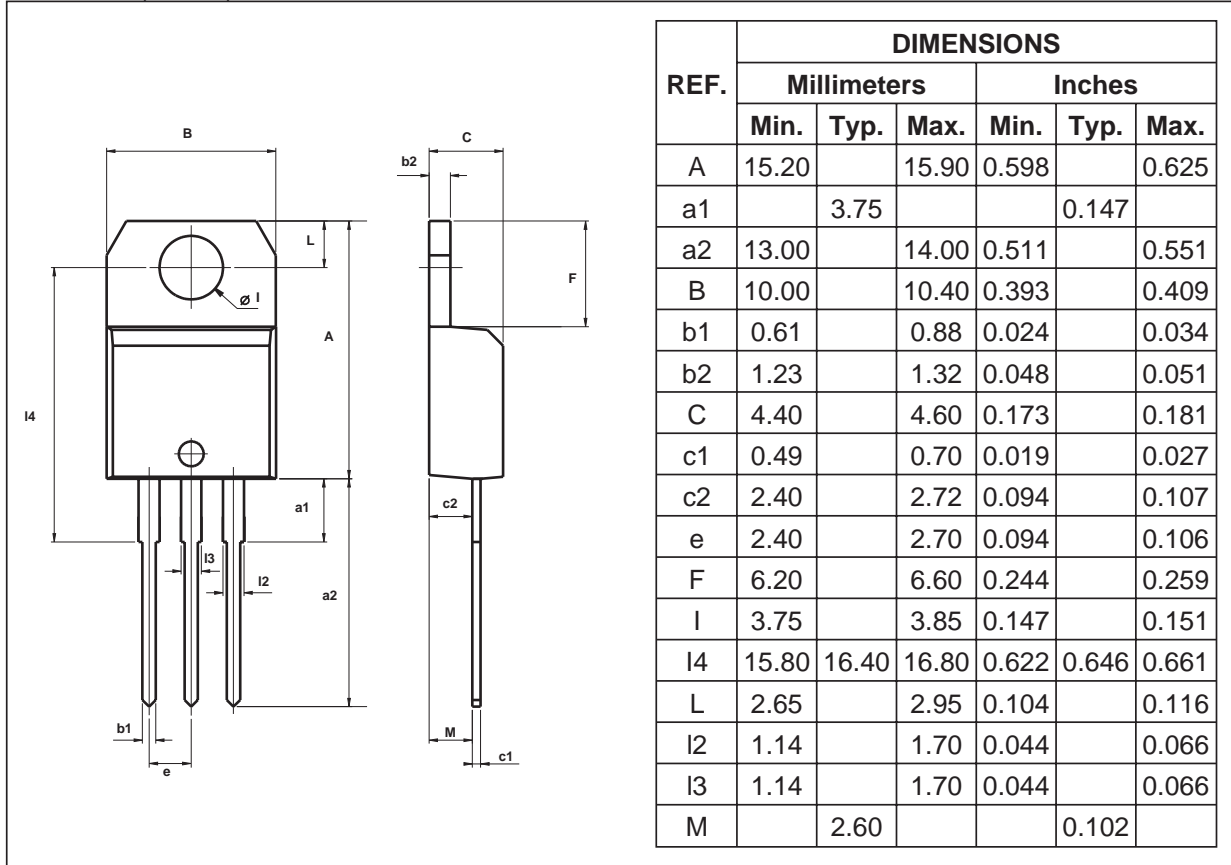


**Fig. 8:** On-state characteristics (maximum values).



**TYN210 ---> TYN1010**

**PACKAGE MECHANICAL DATA**  
TO-220AB (Plastic)



**OTHER INFORMATION**

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
TYNxx10	TYNxx10	TO-220AB	2.3 g	250	Bulk

- Epoxy meets UL94,V0
- Cooling method: C
- Recommended torque value: 0.8 m.N.
- Maximum torque value: 1 m.N.

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